

QUICKSWITCH[®] PRODUCTS HIGH-PERFORMANCE CMOS SIX CHANNEL SP4T MUX/DEMUX

FEATURES:

- Low ON resistance: rbs(on) = 5Ω
- Fast transition time: tTRAN = 6ns
- Wide bandwidth: 700MHz (-3dB point)
- · Crosstalk: -110dB at 50KHz, -68dB at 5MHz, -66dB at 30MHz
- · Off-isolation: -90dB at 50KHz, -60dB at 5MHz, -50dB at 30MHz
- Single 5V supply
- · Can be used as multiplexer or demultiplexer
- · TTL-compatible control inputs
- Ultra-low quiescent current: 9µA
- · Available in QVSOP package

APPLICATIONS:

- · High-speed video signal switching/routing
- HDTV-quality video signal multiplexing
- Audio signal switching/routing
- Data acquisition
- ATE systems
- Telecomm routing
- · Switch between multiple video sources
- · Token Ring transceivers
- High-speed networking

FUNCTIONAL BLOCK DIAGRAM

DESCRIPTION:

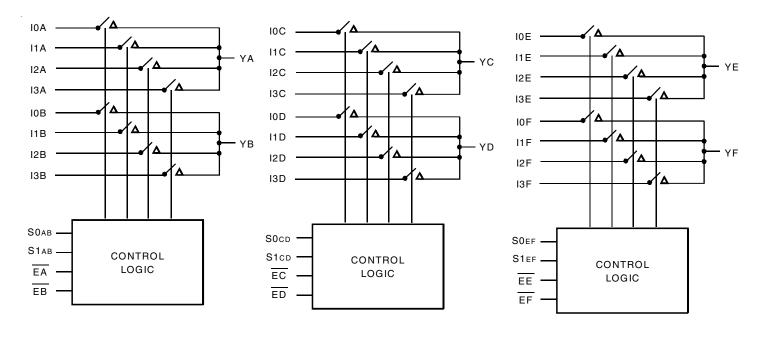
The QS4A215 is a high-performance CMOS six-channel multiplexer/ demultiplexer with individual enables. The low ON-resistance of the QS4A215 allows inputs to be connected to outputs with low insertion loss and high bandwidth. TTL-compatible control circuitry with "Break-Before-Make" feature prevents contention.

The QS4A215 with 700MHz bandwidth makes it ideal for high-performance video signal switching, audio signal switching, and telecom routing applications. High performance and low power dissipation makes this device ideal for battery operated and remote instrumentation applications.

The QS4A215 is offered in the QVSOP package which has several advantages over conventional packages such as PDIP and SOIC, including:

- Reduced signal delays due to denser component packaging on circuit boards
- Reduced system noise due to less pin inductance, resulting in lower ground bounce

The QS4A215 is characterized for operation at -40°C to +85°C.

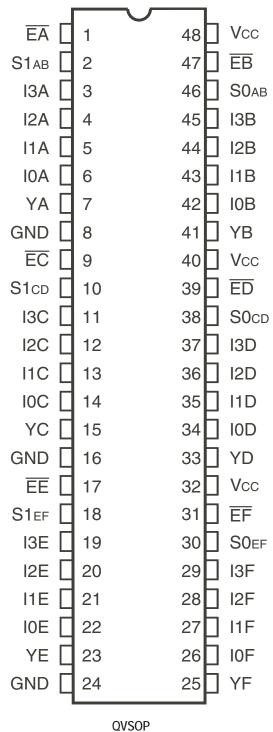


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INDUSTRIAL TEMPERATURE RANGE

JULY 2015

PINCONFIGURATION



TOP VIEW

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max	Unit	
VTERM ⁽²⁾	Supply Voltage to Ground	–0.5 to +7	V	
VTERM ⁽³⁾	DC Switch Voltage Vs	–0.5 to +7	V	
—	Analog Input Voltage	–0.5 to +7	V	
VTERM ⁽³⁾	DC Input Voltage VIN	–0.5 to +7	V	
VAC	AC Input Voltage (pulse width ≤20ns)	-3	V	
Ιουτ	DC Output Current	120	mA	
Рмах	Maximum Power Dissipation	0.7	W	
Tstg	Storage Temperature	–65 to +150	°C	

NOTES:

 Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

2. Vcc terminals.

3. All terminals except Vcc .

PIN DESCRIPTION

Pin Names	I/O	Description
lxx	I/O	Demux Ports A-F
S0XX, S1XX	I	Select Inputs
Ēx	I	Enable Inputs A-F
Yх	I/O	Mux Ports A-F

FUNCTION TABLE(1)

Enable		Select		Mux/Demux		
			Ports		orts	
ĒĀ	ĒB	S 1	S0	YA	YB	Function
Н	Х	Х	Х	Z	Х	Disable A
Х	Н	Х	Х	Х	Z	Disable B
L	L	L	L	I0A	l0B	S1AB, S0AB = 0
L	L	L	Н	I1A	I1B	S1AB, S0AB = 1
L	L	Н	L	I2A	I2B	S1AB, S0AB = 2
L	L	Н	Н	I3A	ІзВ	S1AB, S0AB = 3

NOTE:

1. H = HIGH Voltage Level L = LOW Voltage Level

X = Don't Care

Z = High-Impedance

 This function table represents the function for block "AB". The "CD" block nomenclature substitutes "A" for "C" and "B" for "D". The "EF" block nomenclature substitutes "A" for "E" and "B" for "F".

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified: Industrial: TA = -40° C to $+85^{\circ}$ C. Vcc = 5V ± 5%

Symbol	Parameter	Test Conditions	Min.	Тур. ⁽¹⁾	Max.	Unit
Analog Si	vitch					
Vin	Analog Signal Range ⁽²⁾		-0.5	1	Vcc - 1	V
rds(on)	Drain-source ON resistance ^(2,3)	Vcc = Min., VIN = 0V, ION = 30mA	—	5	7	Ω
		Vcc = Min., VIN = 2.4V, ION = 15mA	_	13	Vcc - 1	
IC(OFF)	Channel Off Leakage Current	$I_N = V_{CC} \text{ or } 0V; Y_N = 0V \text{ or } V_{CC}; \overline{EX} = V_{CC}$	_	10	_	nA
IC(ON)	Channel On Leakage Current	$I_N = Y_N = 0V$	—	10	_	nA
		(each channel is turned on sequentially)				
Digital Co	ontrol					
Vih	Input HIGH Voltage	Guaranteed Logic HIGH for Control Pins	2	_	—	V
VIL	Input LOW Voltage	Guaranteed Logic LOW for Control Pins	-	_	0.8	V
Dynamic (Characteristics					
t TRANS	Switching Time of Mux	RL = 1KΩ, CL = 100pF	0.5	_	6.6	ns
	Sx to Yx	(See Transition Time)				
ton(ĒN)	Enable Turn-On Time	RL = 1KΩ, CL = 100pF	0.5	_	6	ns
	ĒX to Yx	(See Switching Time)				
$tOFF(\overline{EN})$	Enable Turn-Off Time	RL = 1KΩ, CL = 100pF	0.5	_	6	ns
	EX to Yx	(See Switching Time)				
tPD	Group Delay ^(2,4)	RL = 1KΩ, CL = 100pF	—	_	250	ps
f3dB	-3dB Bandwidth	VIN = 1Vp-p, RL = 75Ω	—	700	_	MHz
	Off-isolation	VIN = 1Vp-p, RL = 75Ω, f = 5MHz	_	-60	—	dB
Xtalk	Crosstalk	Vin = 1Vp-p, RL = 75Ω, f = 5MHz	—	-68	-	dB
CMUX(OFF)	Mux Off Capacitance	$\overline{\text{EX}}$ = Vcc, VIN = VOUT = 0V	—	6	_	pF
DEMUX(OFF)	Demux Off Capacitance	\overline{EX} = Vcc, Vin = Vout = 0V	—	14	_	pF
CMUX(ON)	Mux On Capacitance	\overline{EX} = 0V, VIN = VOUT = 0V	—	20	_	pF
CDEMUX(ON)	Demux On Capacitance	\overline{EX} = 0V, VIN = VOUT = 0V	_	20	_	pF
Qcı	Charge Injection	CL = 1000pF	_	1.5		pC

NOTES:

1. Typical values are at Vcc = 5.0V, TA = 25° C.

2. Max value is guaranteed but not production tested.

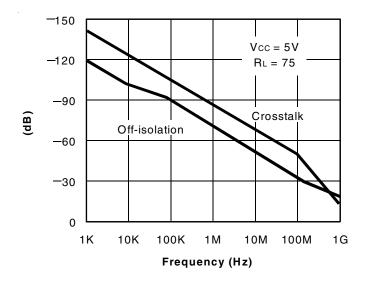
3. Measured by voltage drop between A and C pins or B and D pins at indicated current through the switch. ON resistance is determined by the lower of the voltages on the two (I, Y) pins.

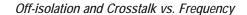
4. The bus switch contributes no group delay other than the RC delay of the ON resistance of the switch and load capacitance. Group delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

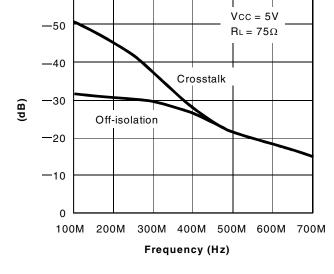
POWER SUPPLY CHARACTERISTICS

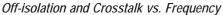
Symbol	Parameter	Test Conditions	Max.	Unit
lccq	Quiescent Power	Vcc = Max., VIN = GND or Vcc, f = 0	9	μA

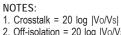
TYPICAL CHARACTERISTICS



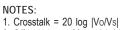








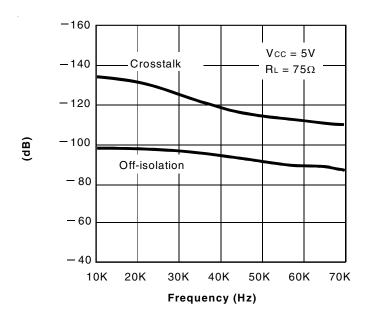
2. Off-isolation = 20 log |Vo/Vs|

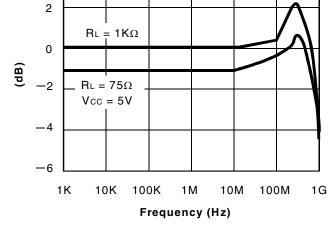


4

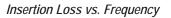
-60

2. Off-isolation = 20 log |Vo/Vs|





Off-isolation and Crosstalk vs. Frequency

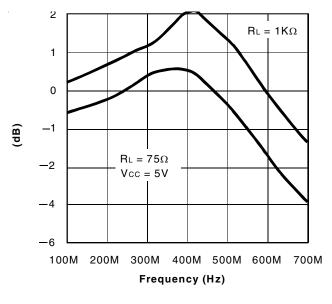


NOTE: 1. Insertion Loss = 20 log |Vo/Vs|

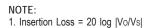
NOTES: 1. Crosstalk = 20 log |Vo/Vs| 2. Off-isolation = 20 log |Vo/Vs|

IDTQS4A215 HIGH-PERFORMANCE CMOS SIX-CHANNEL SP4TMUX/DEMUX

TYPICAL CHARACTERISTICS (CONTINUED)



Insertion Loss vs. Frequency



RON LINK

3.0

2.5

On-Resistance vs. VIN

1.5

VIN (Volts)

2.0

1.0

Vcc = 4.75V

18

16

14

12

10

8

6

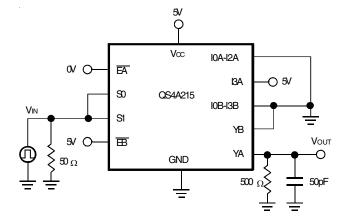
4

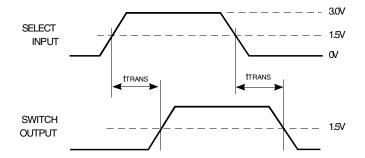
0.0

0.5

r DS(On) - Drain Source On-resistance(0)

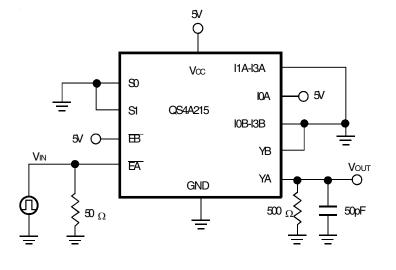
TESTCIRCUITS

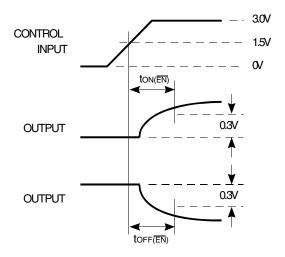




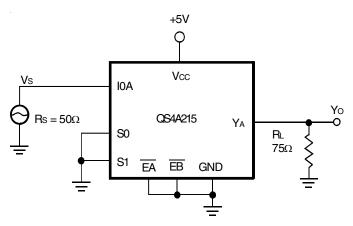
Transition Time

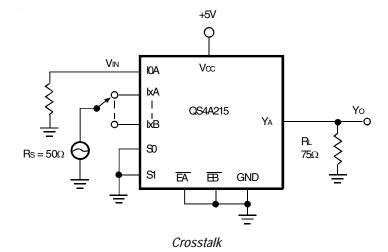
TEST CIRCUITS (CONTINUED)





Enable Switching Time

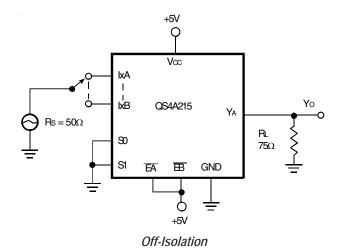




Insertion Loss

NOTE:

1. Insertion Loss = 20 log |Vo/Vs|



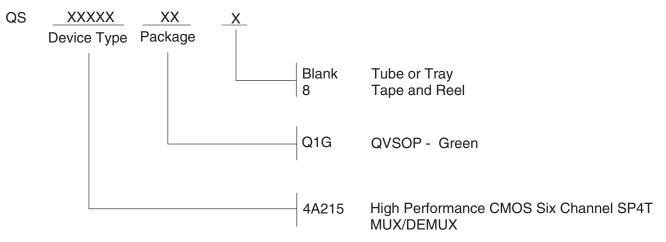
NOTE:

1. Off-isolation = 20 log |Vo/Vs|

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NOTE: 1. Crosstalk = 20 log |Vo/Vs|

ORDERING INFORMATION



DATASHEET DOCUMENT HISTORY

04/13/2014Pg. 7Updated the Ordering Information by removing non green package version, the "IDT" notation and Adding Tape
and Reel information.07/07/2015Pg. 1,7Updated the Ordering Information from QG to Q1G accordingly.

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TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

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